TOSHIBA Diode Silicon Epitaxial Planar Type

# HN2D03F

#### **High-Speed Switching Application**

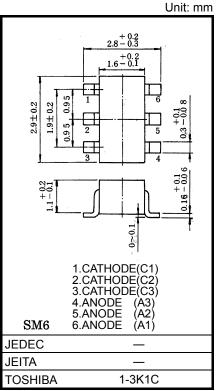
Small package

Low forward voltage : V<sub>F (2)</sub> = 0.94 V (typ.)
 Small total capacitance : C<sub>T</sub> = 2.5 pF (typ.)

### **Absolute Maximum Ratings (Ta = 25°C)**

Characteristic	Symbol	Rating	Unit
Maximum (peak) reverse voltage	$V_{RM}$	420	V
Reverse voltage	V <sub>R</sub>	400	٧
Maximum (peak) forward current	I <sub>FM</sub>	300*	mA
Average forward current	IO	100*	mA
Surge current (10ms)	I <sub>FSM</sub>	2*	Α
Power dissipation	Р	300**	mW
Junction temperature	Tj	150	°C
Storage temperature	T <sub>stg</sub>	-55 to 150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings



Weight: 15 mg (typ.)

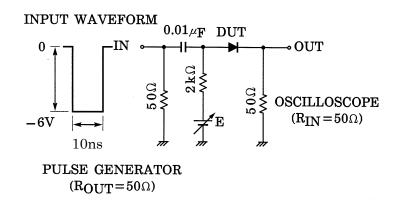
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

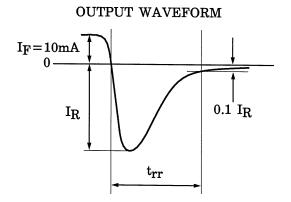
- \*: Absolute Maximum Ratings per each one of Q1, Q2 or Q3. In case of simultaneous use, the Absolute Maximum Ratings per diode shall be derated to 75%.
- \*\*: Total rating

#### Electrical Characteristics (Q1, Q2, Q3, Common, Ta = 25°C)

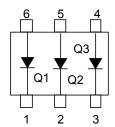
Characteristic	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit
Forward voltage	V <sub>F (1)</sub>	_	I <sub>F</sub> = 10 mA	_	0.8	_	V
	V <sub>F (2)</sub>	_	I <sub>F</sub> = 100 mA	_	0.94	1.3	
Reverse current	I <sub>R (1)</sub>	_	V <sub>R</sub> = 300 V	_	_	0.05	μА
	I <sub>R (2)</sub>	_	V <sub>R</sub> = 400 V	_	_	0.1	
Total capacitance	C <sub>T</sub>	_	V <sub>R</sub> = 0 V, f = 1 MHz	_	2.5	_	pF
Reverse recovery time	t <sub>rr</sub>	_	I <sub>F</sub> = 10 mA (fig.1)	_	0.5	_	μs

## Fig.1 Reverse Recovery Time (trr) Test Circuit

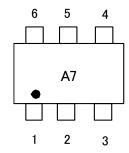


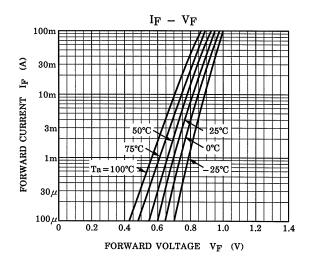


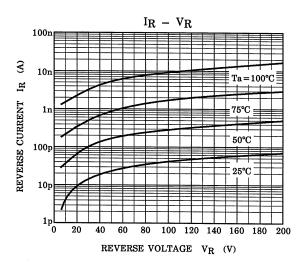
## Pin Assignment (top view)

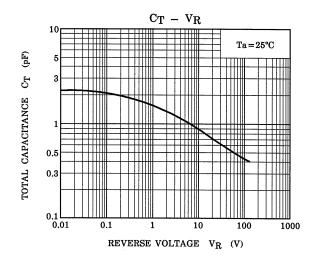


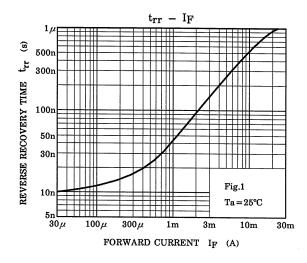
## Marking

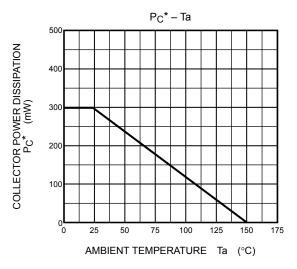












\*Total Rating.

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